

PRIMERGY RX2540 M1

System configurator and order-information guide

October 2014

Contents



Available in November 2014

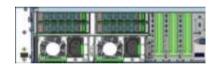
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PRIMERGY Server

Instructions

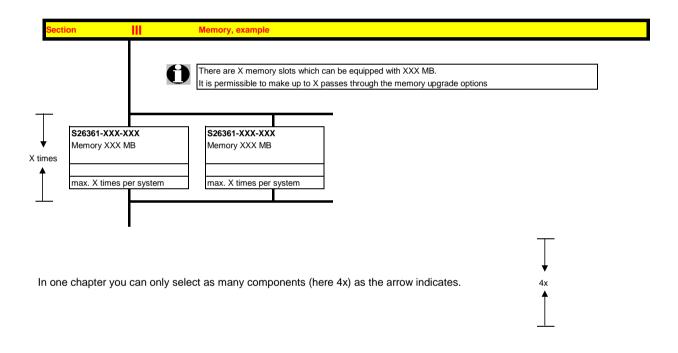
This document contains basic product and configuration information that will enable you to configure your system via PC-/System-Architect.

Only these tools will ensure a fast and proper configuration of your PRIMERGY server or your complete PRIMERGY Rack system.

You can configure your individual PRIMERGY server in order to adjust your specific requirements.

The System configurator is divided into several chapters that are identical to the current price list and PC-/SystemArchitect.

Please follow the lines. If there is a junction, you can choose which way or component you would like to take. Go through the configurator by following the lines from the top to the bottom.



Please note that there are information symbols which indicate necessary information.



For further information see:

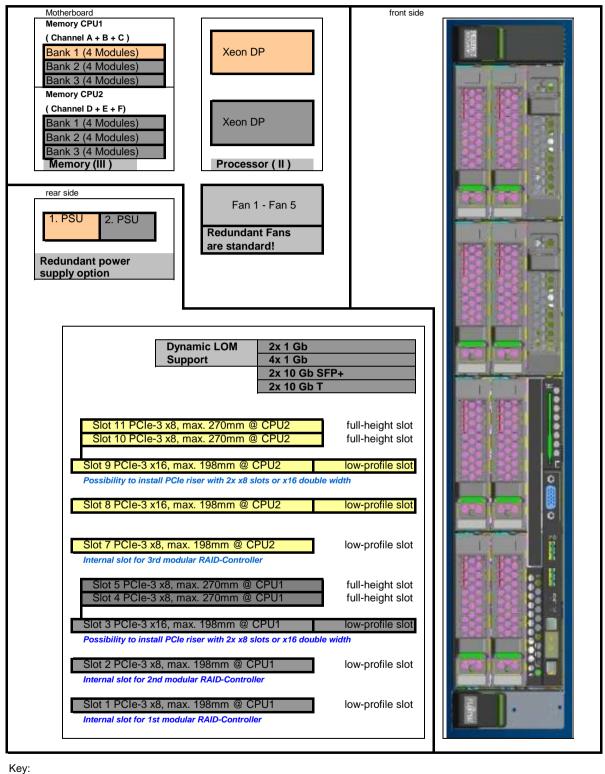
http://ts.fujitsu.com/products/standard_servers/inc (internet)

https://partners.ts.fujitsu.com/com/order-supply/configurators/primergy_config/current/Pages/default.aspx (extranet)

Configuration diagram PRIMERGY RX2540 M1 LFF

System unit (I)

with up to 4x, 8x or 12x 3.5" Hard disk drives





Section

Basic unit



System unit consisting of:

- * 2U Housing without power supply modules
- Basic units with:
- 2 Hot-Plug Power Supply Bays
- 5 Fans (full redundancy)
- 12 memory DIMMs per CPU (max 768GB) => Total 24 DIMMs (max 1536GB) for two CPU's as soon as available: max 3072GB per system with two CPU's
- SAS Backplanes for 4x, 8x or 12x 3.5" HD LFF or for 8, 16 or 24x 2.5" HD SFF or PCle SFF backplanes (Feb. 2015) with cable connection to on-board, modular RAID Controller or PCle Switch

* Drives/Bays

- 4, 8 or 12 bays 1" for hot plug 3.5" HD (1" high) or 8, 16 or 24 bays for hot plug 2.5" HD (Feb. 2015)
- 1 bay SATA-DVD-RW 0,4" height (option, not for basic unit with 12x 3.5" HD and with 24 x 2,5" HD)
- 1 bay for 5.25" and 1.6" high Backup device, not possible for basic units with 3.5" HD and for basic unit with 24 x 2.5" HD
- 'Integrated ServerView Diagnostics Technology (Diagnosis LED's) for indication of internal failed components

Systemboard D3289 with:

* Up to two Xeon DP CPU's (Socket-R3)

with 2 serial QPI links (Quick Path Interconnect) and four memory channels per CPU First CPU has to be selected for an orderable basic unit,

- * Chipset Intel® C610 Series (codenamed Wellsburg)
- * 6 PCI slots low profile: 3x PCIe-3 x16 (2 slots are connected to CPU 2 and are useable with configured 2nd CPU only!)
 - 2x PCle-3 x8 (notched to install x16 cards, 1 slot is connected to CPU 2)
 - 1x PCIe-3 x8 (may be used for modular RAID controller)
- 8 PCI slots are possible with PCIe riser card options (4x full height, please see Section VII, Nov. 2014)
- * 24 memory slots (each CPU 12 slots) DDR4 are available
- Memory is divided into 12 DIMMs per CPU (4 channels with 3 slots per channel) First Memory (one module) has to be selected for an orderable basic unit per CPU
- * Dynamic LOM

Quad Port 1Gb/10Gb Emulex Controller XE104 (Skyhawk) on motherboard up to Quad Port 1Gb or

Dual Port 10Gb NIC plus full CNA functionality with iSCSI-, FCoE- RDMA and UMC support connectors (external interfaces) are added by different variants of DynamicLoM interface modules

The Service LAN-port can be switched alternatively to a standard LAN (port 1)

- * iRMC S4 (integrated Remote Management Controller) on-board server management controller with dedicated 10/100/1000 Service LAN-port and integrated graphics controller.
- * Graphics Controller integrated in iRMC S4 (integrated Remote Management Controller): 1600x1200x16bpp 60Hz, 1280x1024x16bpp 60Hz, 1024x768x32bpp 75Hz, 800x600x32bpp 85Hz, 640x480x32bpp 85Hz
- (1280x1024x24bpp 60Hz only possible if local monitor or remote video redirection is off)

Interfaces at the rear:

- * 1x RS-232-C (serial, 9 pins) (usable for BMC or OS or shared)
- * 1x VGA (15 pins)
- * 2x USB **3.0** (UHCI) with **5 GBit/s**, no USB wakeup
- * 2x USB 2.0 (UHCI) with 480MBit/s, no USB wakeup
- * 2x or 4x LAN 1Gb RJ45 or 2x LAN 10 Gb SFP+ or RJ45, 1x Service-LAN RJ45

Interfaces on the front:

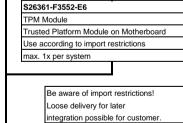
- * 2x USB 3.0 (UHCI) with 5 GBit/s, no USB wakeup (only 1x USB 2.0 for basic unit with 12x 3.5" HD and with 24 x 2,5" HD
- * 1x VGA (15 pins) as an option (not for basic unit with 12x 3.5" HD and with 24 x 2,5" HD)

Interfaces internal:

- * 1 port for UFM Module
- * 1 port for backup device USB3.0 (USB 3.0 Type A Connector)
- * 1x SATA 3Gbit interface for ODD
- 1x SATA 3GBit for DOM
- * 8x SATA 3Gbit interface for 8 SATA HD (first release for 4 SATA HD only!)

Software:

- * ServerView Suite Software package incl. ServerStart, ServerBooks, Management Software and Updates
- * Documentation engl. (multilingual on CD)



В

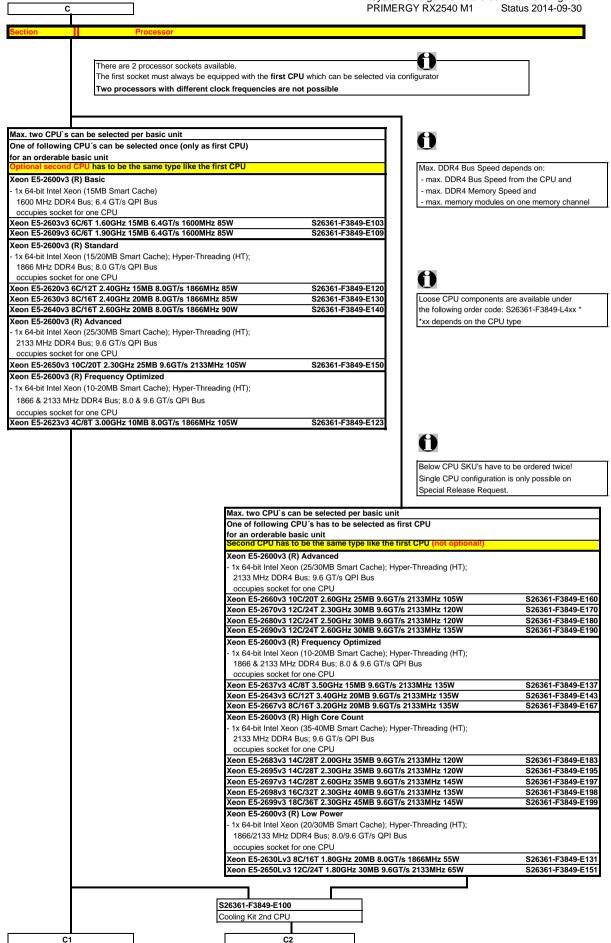
S26361-F3552-L6

TPM Module add-on kit
for later integration (loose delivery)

Trusted Platform Module on Motherboard
Use according to import restrictions
max. 1x per system

PRIMERGY Classic 19" rack is not supported

С



C1	

c2 PRIMERGY RX2540 M1	
One of following CPU's has to be selected as second CPU	
Optional second CPU has to be the same type like the first CPU	
Xeon E5-2600v3 (R) Basic	
- 1x 64-bit Intel Xeon (15MB Smart Cache)	
1600 MHz DDR4 Bus; 6.4 GT/s QPI Bus	
occupies socket for one CPU	200001 50010 51
Xeon E5-2603v3 6C/6T 1.60GHz 15MB 6.4GT/s 1600MHz 85W	S26361-F3849-E1
Xeon E5-2609v3 6C/6T 1.90GHz 15MB 6.4GT/s 1600MHz 85W	S26361-F3849-E1
Xeon E5-2600v3 (R) Standard	
 1x 64-bit Intel Xeon (15/20MB Smart Cache); Hyper-Threading (HT); 1866 MHz DDR4 Bus; 8.0 GT/s QPI Bus 	
occupies socket for one CPU	
Xeon E5-2620v3 6C/12T 2.40GHz 15MB 8.0GT/s 1866MHz 85W	S26361-F3849-E1
Xeon E5-2630v3 8C/16T 2.40GHz 20MB 8.0GT/s 1866MHz 85W	S26361-F3849-E1
Xeon E5-2640v3 8C/16T 2.60GHz 20MB 8.0GT/s 1866MHz 90W	S26361-F3849-E1
Xeon E5-2600v3 (R) Advanced	
- 1x 64-bit Intel Xeon (25/30MB Smart Cache); Hyper-Threading (HT);	
2133 MHz DDR4 Bus; 9.6 GT/s QPI Bus	
occupies socket for one CPU	
Xeon E5-2650v3 10C/20T 2.30GHz 25MB 9.6GT/s 2133MHz 105W	S26361-F3849-E1
Xeon E5-2660v3 10C/20T 2.60GHz 25MB 9.6GT/s 2133MHz 105W	S26361-F3849-E1
Xeon E5-2670v3 12C/24T 2.30GHz 30MB 9.6GT/s 2133MHz 120W	S26361-F3849-E1
Xeon E5-2680v3 12C/24T 2.50GHz 30MB 9.6GT/s 2133MHz 120W	S26361-F3849-E18
Xeon E5-2690v3 12C/24T 2.60GHz 30MB 9.6GT/s 2133MHz 135W	S26361-F3849-E19
Xeon E5-2600v3 (R) Frequency Optimized	
- 1x 64-bit Intel Xeon (10-20MB Smart Cache); Hyper-Threading (HT);	
1866 & 2133 MHz DDR4 Bus; 8.0 & 9.6 GT/s QPI Bus	
occupies socket for one CPU	
Xeon E5-2623v3 4C/8T 3.00GHz 10MB 8.0GT/s 1866MHz 105W	S26361-F3849-E1
Xeon E5-2637v3 4C/8T 3.50GHz 15MB 9.6GT/s 2133MHz 135W	S26361-F3849-E13
Xeon E5-2643v3 6C/12T 3.40GHz 20MB 9.6GT/s 2133MHz 135W	S26361-F3849-E14
Xeon E5-2667v3 8C/16T 3.20GHz 20MB 9.6GT/s 2133MHz 135W	S26361-F3849-E1
Xeon E5-2600v3 (R) High Core Count	
- 1x 64-bit Intel Xeon (35-40MB Smart Cache); Hyper-Threading (HT);	
2133 MHz DDR4 Bus; 9.6 GT/s QPI Bus	
occupies socket for one CPU	
Xeon E5-2683v3 14C/28T 2.00GHz 35MB 9.6GT/s 2133MHz 120W	S26361-F3849-E1
Xeon E5-2695v3 14C/28T 2.30GHz 35MB 9.6GT/s 2133MHz 120W	S26361-F3849-E1
Xeon E5-2697v3 14C/28T 2.60GHz 35MB 9.6GT/s 2133MHz 145W	S26361-F3849-E1
Xeon E5-2698v3 16C/32T 2.30GHz 40MB 9.6GT/s 2133MHz 135W	S26361-F3849-E1
Xeon E5-2699v3 18C/36T 2.30GHz 45MB 9.6GT/s 2133MHz 145W	S26361-F3849-E1
Xeon E5-2600v3 (R) Low Power	
- 1x 64-bit Intel Xeon (20/30MB Smart Cache); Hyper-Threading (HT);	
1866/2133 MHz DDR4 Bus; 8.0/9.6 GT/s QPI Bus	
occupies socket for one CPU	
Xeon E5-2630Lv3 8C/16T 1.80GHz 20MB 8.0GT/s 1866MHz 55W	S26361-F3849-E1
Xeon E5-2650Lv3 12C/24T 1.80GHz 30MB 9.6GT/s 2133MHz 65W	S26361-F3849-E1



Separate orderable CPU upgrade kits					
S26361-F3849-L403	Xeon E5-2603v3 6C/6T 1.60GHz 15MB 6.4GT/s 1600MHz 85W				
S26361-F3849-L409	Xeon E5-2609v3 6C/6T 1.90GHz 15MB 6.4GT/s 1600MHz 85W				
S26361-F3849-L420	Xeon E5-2620v3 6C/12T 2.40GHz 15MB 8.0GT/s 1866MHz 85W				
S26361-F3849-L430	Xeon E5-2630v3 8C/16T 2.40GHz 20MB 8.0GT/s 1866MHz 85W				
S26361-F3849-L440	Xeon E5-2640v3 8C/16T 2.60GHz 20MB 8.0GT/s 1866MHz 90W				
S26361-F3849-L450	Xeon E5-2650v3 10C/20T 2.30GHz 25MB 9.6GT/s 2133MHz 105W				
S26361-F3849-L423	Xeon E5-2623v3 4C/8T 3.00GHz 10MB 8.0GT/s 1866MHz 105W				

D

D

Section III Memory



- There are 12 memory slots per CPU for max.

768GB LRDIMM (12x 64GB 4R)

384GB RDIMM (12x 32GB 2R)

=> max. 1.536GB for two CPUs (768GB per CPU), using LRDIMM

- The memory area is divided into 4 channels per CPU with 3 slots per channel
- Slot 1 of each channel belongs to memory bank 1, the slot 2 belongs to memory bank 2, slot 3 belongs to memory bank 3

Registered and Load Reduced DIMMs can be selected

No mix of registered and load reduced modules is allowed.

Memory will be operated at 1.2V.

Depending on the CPU following memory speeds will be reached:

In a single DIMM per channel configuration 2133MHz will be supported

This is also valid for a dual LRDIMM configurations (2166MHz)

In a dual RDIMM configuration 1866MHz will be supported

All 3DPC configurations support 1600MHz

SDDC (Chipkill) is supported for registered and load reduced x4 organized memory modules

1.) In the "Independent Channel Mode" the following configuration is possible

Channels can be populated in any order in Independent Channel Mode. All four channels may be populated in any order and have no matching requirements. All channels must run at the same interface frequency but individual channels may run at

 $\label{eq:case_def} \mbox{different DIMM timings (RAS latency, CAS latency, and so forth)}$

No mix of registered and load reduced modules is allowed.

2.) "Rank Sparing Mode" configuration

Within a memory channel, one rank is a spare of the other ranks.

The Spare Rank is held in reserve and is not available as system memory

For the effective memory capacity, please refer to the spreadsheet below.

The BIOS is set to the rank sparing setting.

Minimum configuration is: 2x 1R, 2x 2R or 1x4R DDR4 module per channel

3.) "Performance Mode" configuration

In this configuration, the memory module population ex factory is spread across all channels.

The BIOS is set to the maximum performance for memory.

Minimum configuration is four identical modules per CPU

4.) "Mirrored Channel Mode" configuration

Each memory bank can optionally be equipped with four registered or load reduced DDR4 modules

In each memory bank channel A and B / C and D of CPU 1 or channel E and F / G and H of CPU 2 have to be equipped with identical modules for mirrored channel mode.

In channel B / D is always the mirrored memory of channel A / B of CPU 1 $\,$

In channel F / H is always the mirrored memory of channel E / G of CPU 2

Minimum configuration is four identical modules per CPU

E

E

326361-F3694-E10

Independent Mode

independent Channel Mode allows all channels to be populated in any order. No specific Memory RAS features are defined

Requires min 1 memory Module per CPU

S26361-F3694-E1

Rank Sparing Mode Installation

BIOS Setup factory preinstalled to this mode. One Rank is spare of other ranks on the same channel. Spare Rank is not shown in System Memory. For effective capacity within a channel, please have a look below.

Requires min 2x 1R/2R or 1x 4R modules per CPU

S26361-F3694-E2

1x per CPU

Performance Mode Installation

BIOS Setup factory preinstalled for maximum Performance, Four identical memory modules

will be equipped in one memory bank to achieve highest memory performance. All four modules are active and full capacity can be used.

Multiple of 4 identical modules to be configured per CPU

S26361-F3694-F3

Mirrored Channel Mode Installation

BIOS Setup factory preinstalled to this mode. Four identical memory modules are always equipped in one memory bank to use the

Mirrored channel Mode. Only two modules contain active data, the remain two modules contain mirrored data

Multiple of 4 identical modules to be configured per CPU



Effective Memory capacity / Rank Sparing Mode, 1 Channel populated

		RDIMM	LRD	IMM	
	8GB 1R	16GB 2R	32GB 2R	32GB 4R	64GB 4R
1DPC				24GB	48GB
2DPC	8GB	24GB	48GB	56GB	112GB
3DPC	DPC 16GB 40GB 80GB		88GB	176GB	



Minimum one memory module or order code per CPU = first memory

S26361-F3844-E518



Note 1

Max. DDR4 memory speed depends on the memory configuration (No of mem modules per channel) as well as on the CPU type. The memory channel with the lowest speed defines the speed of all CPU channels in the system, also for the channels of the second CPU if configured.

For real memory speed (depending on memory type / population), please check the spreadsheet "Memory speed" below



Note 2)

34GB (1x64GB) 4Rx4 DDR4-2133 LR ECC

Mix of memory modules is only possible within the same group

Registered Memory (RDIMM) with SDDC (chipkill) support one DDR4 registered ECC memory Module, 1.2V Choose up to 12 order codes per CPU 8GB (1x8GB) 1Rx4 DDR4-2133 R ECC S26361-F3843-E514 16GB (1x16GB) 2Rx4 DDR4-2133 R ECC S26361-F3843-E516 12x per 32GB (1x32GB) 2Rx4 DDR4-2133 R ECC S26361-F3843-E517 CPU, max. Registered Memory (RDIMM) no SDDC (chipkill) support one DDR4 registered ECC memory Module, 1,2V 3 modules per channel Choose up to 12 order codes per CPU 3GB (1x8GB) 2Rx8 DDR4-2133 R ECC S26361-F3843-E515 oad Reduced Memory (LRDIMM) with SDDC (chipkill) support one DDR4 load reduced ECC memory Module, 1.2V Choose up to 12 order codes per CPU 32GB (1x32GB) 4Rx4 DDR4-2133 LR ECC S26361-F3844-E517

as soon as available

as soon as available

F

Memory Configuration PRIMERGY RX2540 M1

Each CPU offers 12 Slots for DDR4 Memory Modules organised in 3 Banks and 4 Channels.

If you need more than 12 Slots you have to configure the 2nd CPU.

Depending on the amount of memory configured you can decide between 4 basic modes of operation (see explanation below).

There are 2 different kinds of DDR4 Memory Modules available: RDIMM and LRDIMM Mix of RDIMM and LRDIMM is not allowed.

Mode	Configuration	RDIMM	RDIMM	Application
		KDIIVIIVI	LRDIMM	
		х8	x4	
SDDC (chipkill) support	any	no	yes	detect multi-bit errors
Independant Channel Mode	1, 2 or 3 Modules per Bank	yes	yes	offers max. flexibility, upgradeability, capacity
Mirrored Channel Mode *)	4 identical Modules / Bank	no	yes	offers maximum security
Performance Mode	4 identical Modules / Bank	yes	yes	offers maximum performance and capacity
Rank Sparing Mode *)	min. 2 Ranks / Channel	no	yes	balances security and capacity

^{*)} For the delivery ex works the system will be prepared with dedicated BIOS setting.

Capacity	Configuration	RDIMM	LRDIMM	Notes
Min. Memory per CPU	1 Module / CPU	1x8GB	1x32GB	with one CPU
Max. Memory per CPU	12 Modules / CPU	12x32GB	12x64GB	with one CPU
Max. Memory per System	24 Modules / System	768GB	1536GB	if second CPU is configured

Memory-Speed:

Max. DDR4 memory speed depends on the memory configuration on one memory channel and the speed of the CPU The memory channel with the lowest speed defines the speed of all CPU channels in the system

Mem. Speed provided by CPU	Real	max	imun	n mer	nory-	bus s	peed depending on CPU type, memory configuration (D and voltage setting (BIOS)
		DIMN 33MF			RDIM 33MI		
Voltage setting (BIOS)	1.2V		1.2V				
-	1	2	3	1	2	3	
	DPC	DPC	DPC	DPC	DPC	DPC	
CPU with 2133MHz DDR4 Bus	2133	1866	1600	2133	2133	1600	2133MHz under test; available in 11/2014
CPU with 1866MHz DDR4 Bus	1866	1866	1600	1866	1866	1600	
CPU with 1600MHz DDR4 Bus	1600	1600	1600	1600	1600	1600	

1R - Single Rank 4R - Quad Rank 2R - Dual Rank 8R - Eight Rank

1DPC = 1 DIMM per Channel 2DPC = 2 DIMM per Channel 3DPC = 3 DIMM per Channel

Configuration hints:

- The memory sockets on the systemboard offer a color coding:

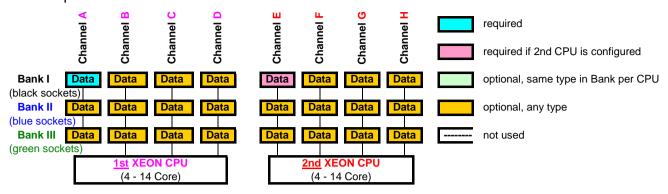
Bank I black sockets
Bank II blue sockets
Bank III green sockets

- A so called Bank consits of 1 memory module on every Channel available on one CPU (examples see below)

Bank I on CPU 1/2 up to 4 memory modules connected to Channel A - H on the 1st/2nd CPU up to 4 memory modules connected to Channel A - H on the 1st/2nd CPU Bank III on CPU 1/2 up to 4 memory modules connected to Channel A - H on the 1st/2nd CPU

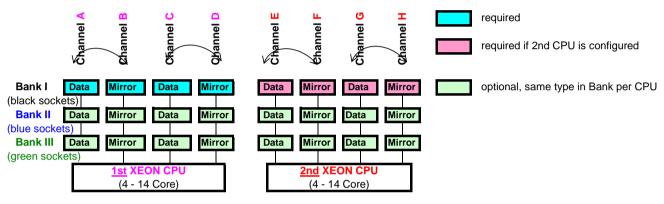
- See below and next page for a detailed descriptions of the memory configuration supported.

1. Independent Channel Mode



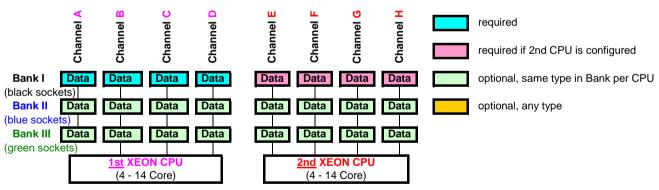
Independent Channel Mode allows all channels to be populated in any order
Can run with differently rated DIMMs and use the settings of the slowest DIMM installed in the system

2. Mirrored Channel Mode



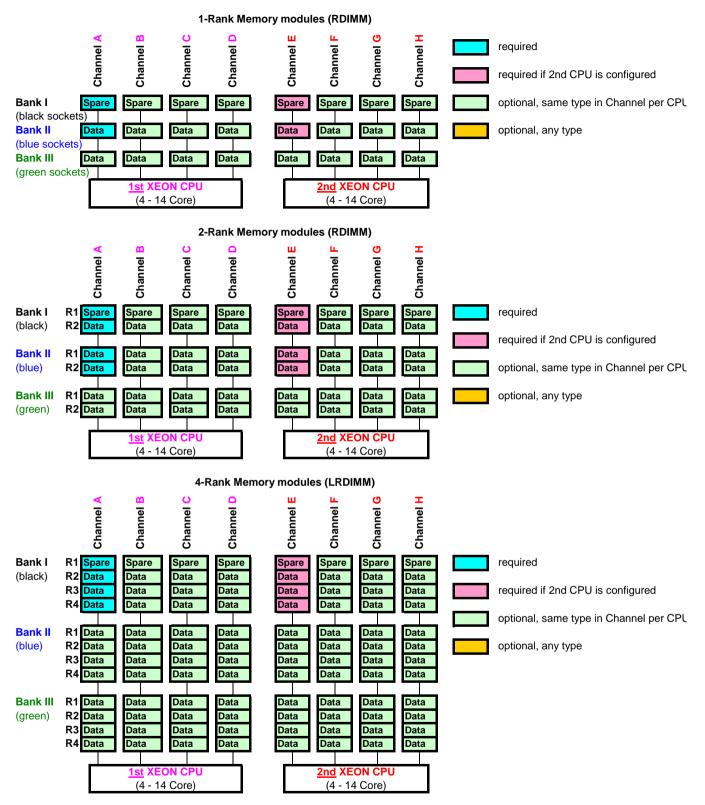
Mirrored Channel Mode requires identical modules on channel A,B, C, D (1st CPU) or channel E, F, G and H (2nd CPU) 50% of the capacity is used for the mirror => the available memory for applications is only half of the installed memory If this mode is used, a multiple of 4 identical modules has to be ordered.

3. Performance Channel Mode



Performance Channel Mode requires identical modules on all channels of each Bank per CPU. If this mode is used, a multiple of 4 identical modules has to be ordered.

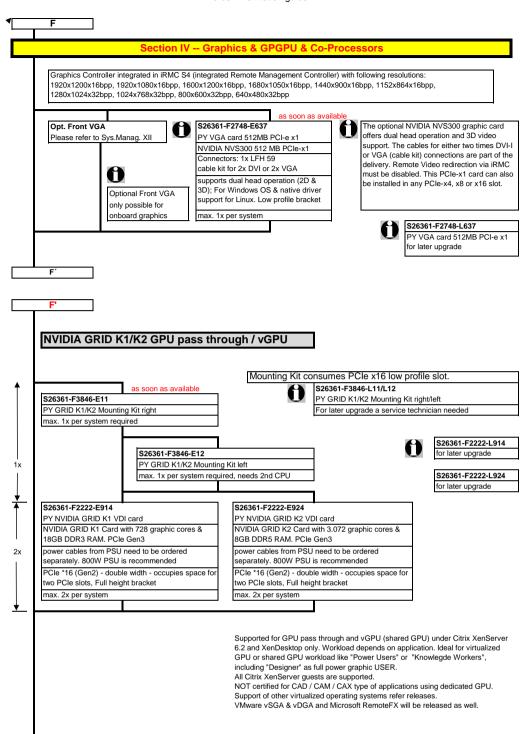
4. Rank Sparing Mode

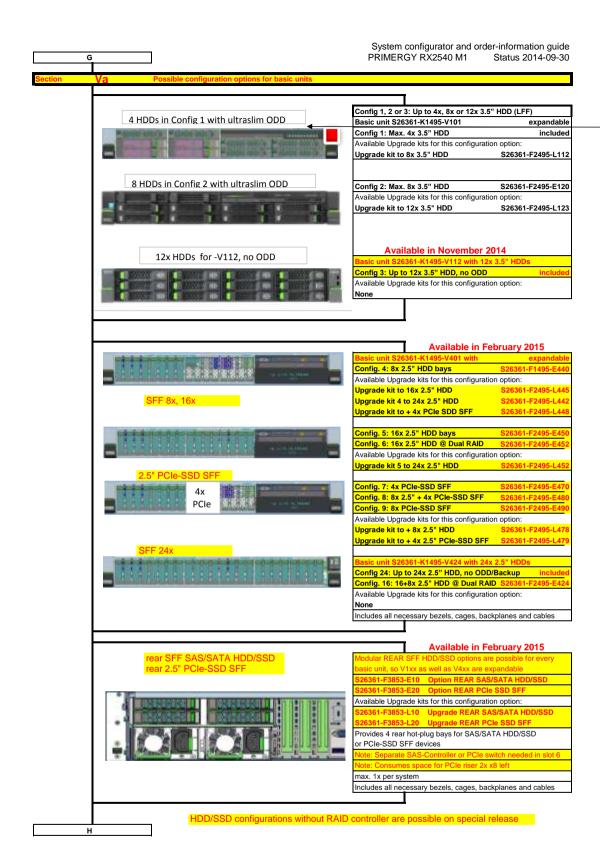


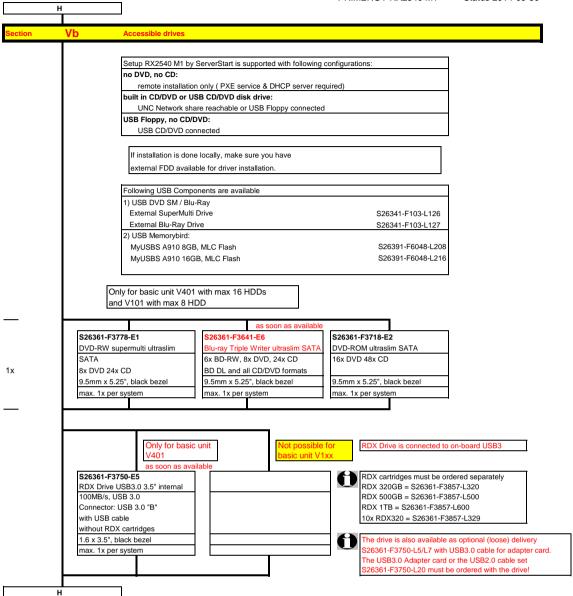
Rank Sparing Mode requires identical modules (same capacity and technology) within the same channel. The available memory for applications will vary depending on configuration. Please refer to the spreadsheet above "Effective Memory capacity with active Rank Sparing Mode". Population rule for Rank sparing mode is to achieve max. available memory, e.g. 6 DIMMs will be spread across two channels, each with 3DPC

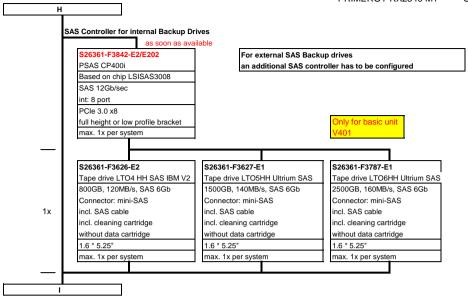
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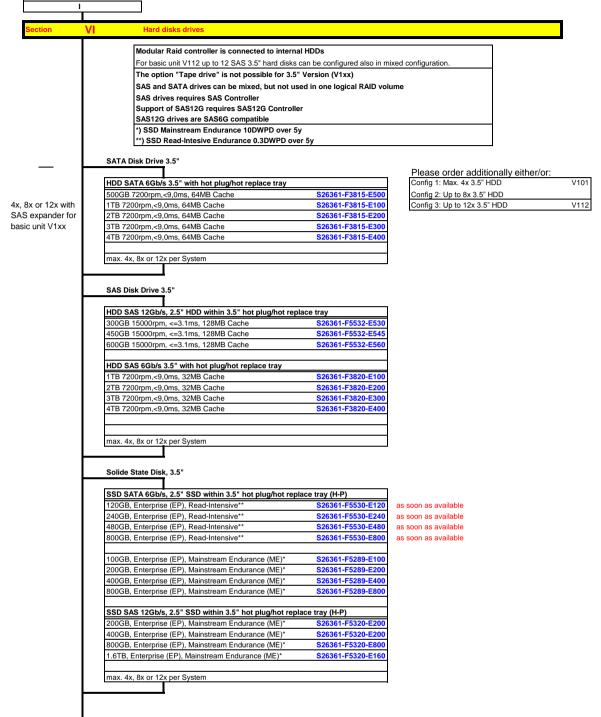
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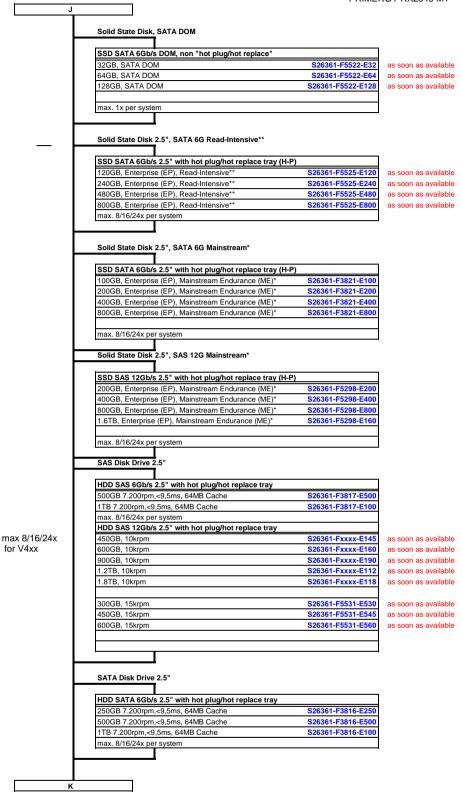


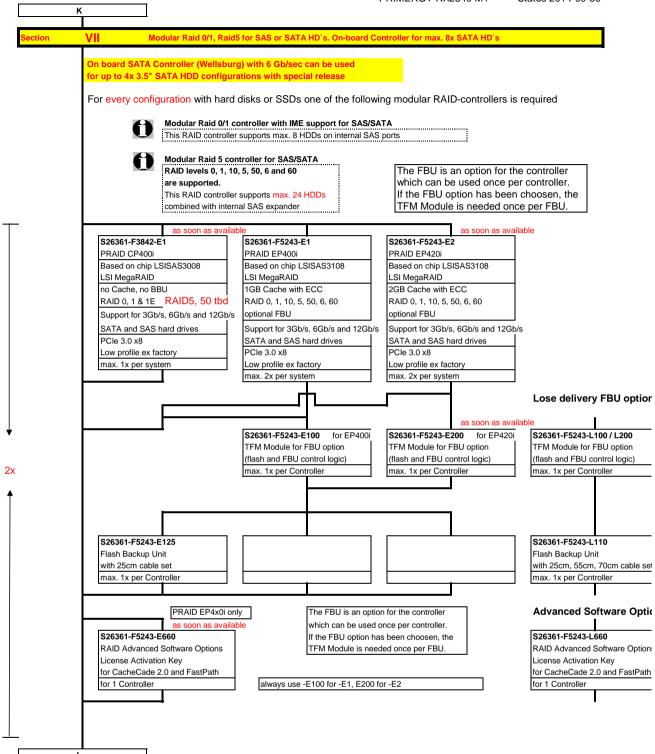


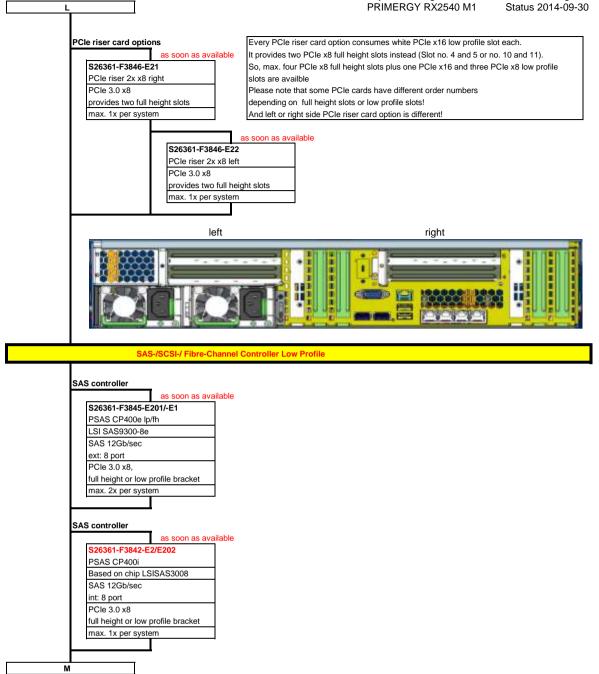


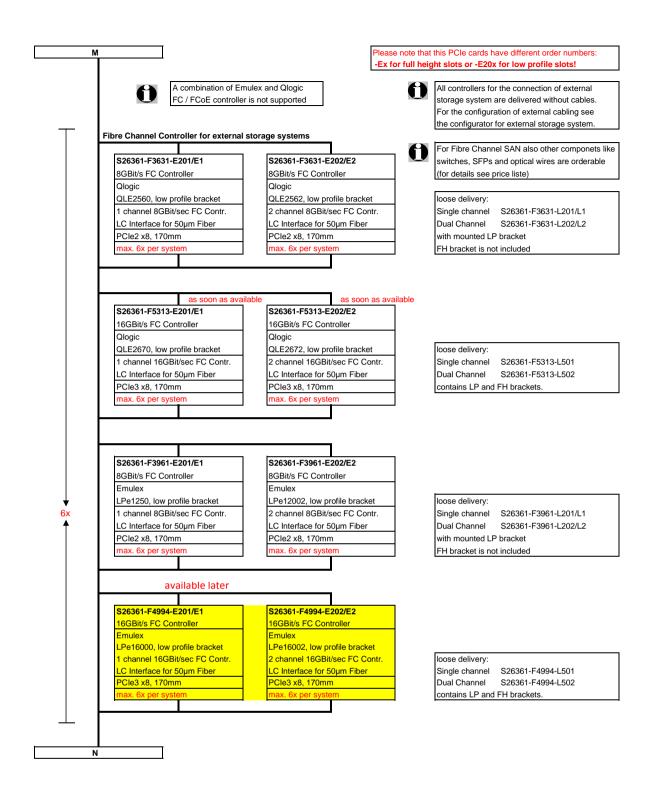


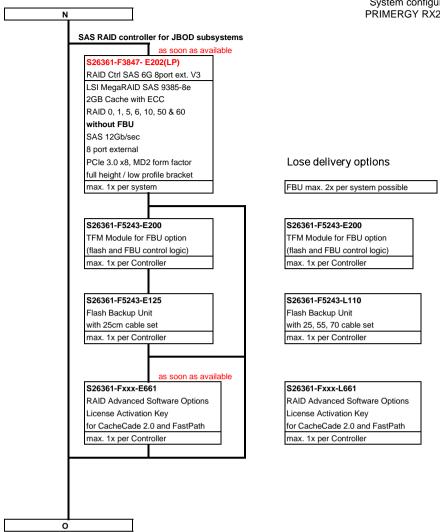


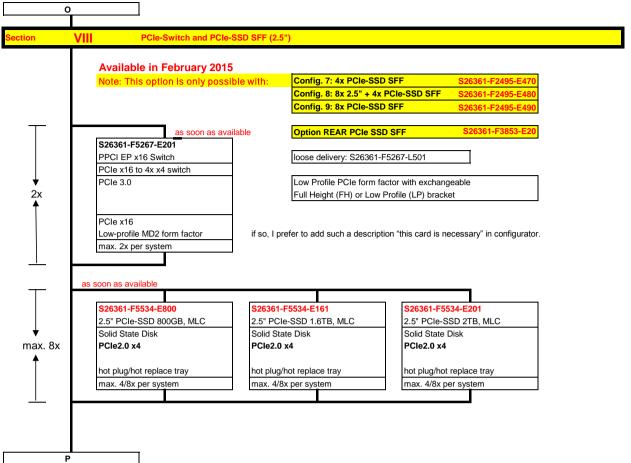


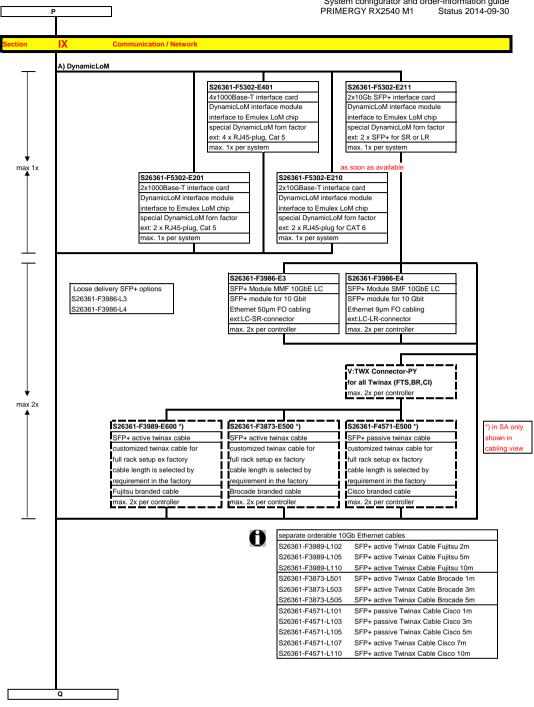


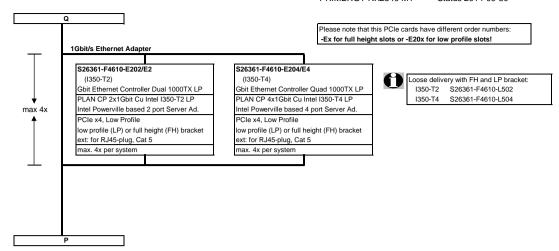


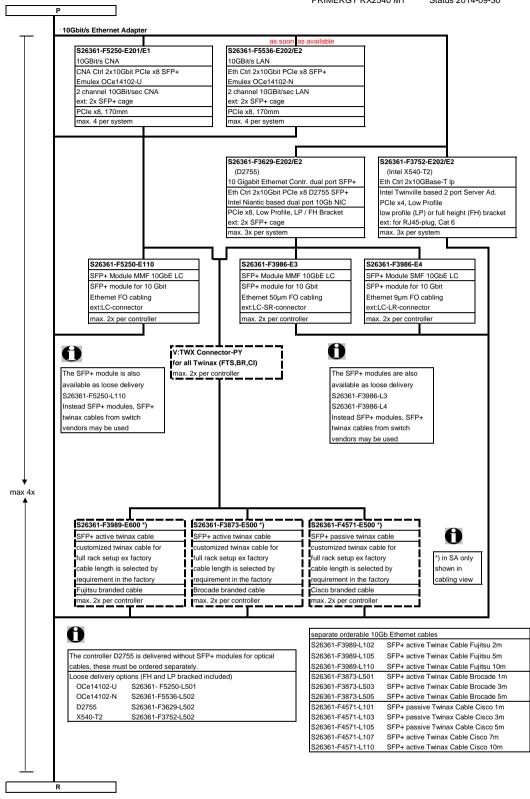


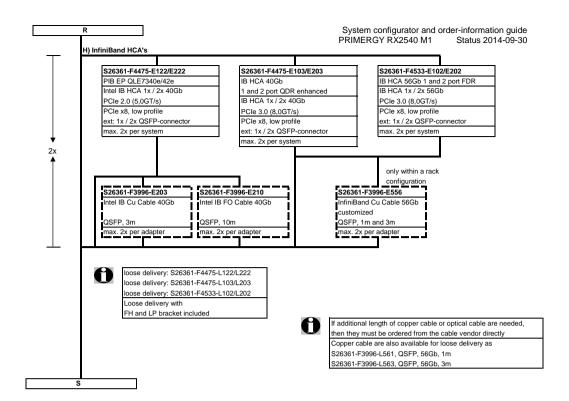


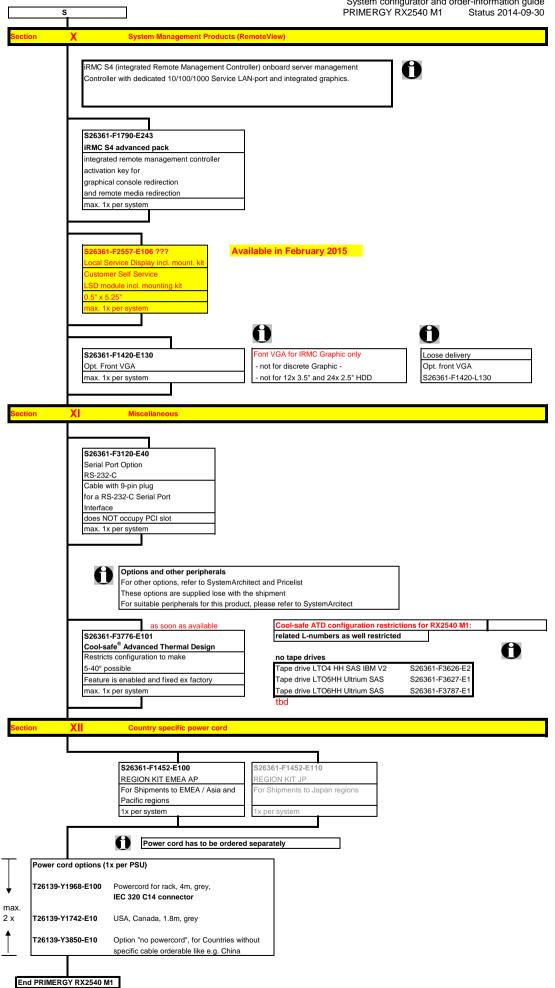












Change Report

Date	Order number	Changes
2014-09-29		2DPC RDIMM configuration @ 2.133MHz available in 11/2014 (remark added)
2014-09-25	FC Controller 16000/16002	release later
2014-09-12		GRID Cards, Mixed configurations of GRID K1 & K2 supported as well
2014-09-08	S26361-F5522-E*	SATADOM order number corrected from *F5222* to *F5522*
2014-09-08	S26361-F5531-E*	Added 2.5" SAS 12G 15Krpm 300GB, 450GB, 600GB HDD
2014-09-08	S26361-F3816-E250	Added 2.5" BC-SATA 250GB HDD
2014-09-05		HDD/SSD configurations without RAID controller are possible on special release only
2014-09-05	S26361-F3718-E2	DVD-ROM ultraslim SATA added
2014-09-05	S26361-F3641-E6	Blu-ray Triple Writer ultraslim SATA added
2014-09-02	S26361-F5536-E202/E2	added Emulex OCe14102-N 10Gb LAN
2014-09-02	S26361-F3516-E201/E1	deleted Gigabit Ethernet Controller 1000TX LP
2014-09-01		First Release